MIE05W0505BGYE

5V, 0.5W, Regulated, 3kV$_{RMS}$ Isolated DC/DC Module

DESCRIPTION

The MIE05W0505BGYE is an isolated, regulated, DC/DC module. It can support 3V to 5.5V input voltage (V_{IN}) applications. With excellent load and line regulation, it supports up to 0.5W of output power (P_{OUT}).

The MIE05W0505BGYE integrates power MOSFETs, transformer, and feedback (FB) circuit all in one chip, achieving excellent performance and saving size.

The MIE05W0505BGYE supports a regulated output voltage (V_{OUT}). When V_{OUT} drops below the target voltage (3.3V or 5V), the IC begins switching, delivering power from the VIN pin to the VOUT pin until V_{OUT} reaches the target voltage again.

The device also integrates a V_{OUT} feedback block, which can regulate V_{OUT} without the need for a traditional optocoupler and a precision programmable reference IC. This small solution provides high reliability compared to traditional isolated power modules.

Full protection features include short-circuit protection (SCP) and over-temperature protection (OTP).

The MIE05W0505BGYE is available in a small SOIC-8 WB package.

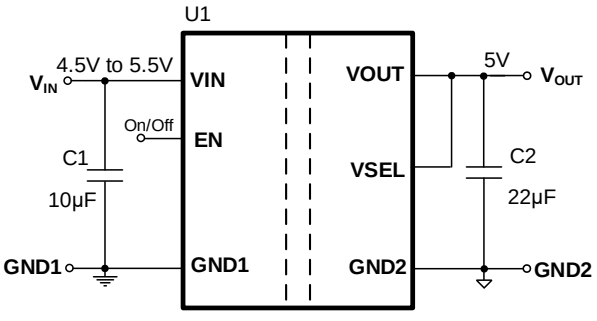
FEATURES

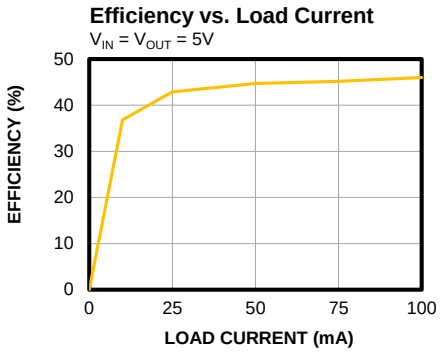
- 3V to 5.5V Input Voltage (V_{IN}) Operation Range
- Selectable 5V or 3.3V Output Voltage (V_{OUT})
  - 5V to 5V: ≥100mA Available Load Current (I_{LOAD})
  - 5V to 3.3V: ≥100mA Available I_{LOAD}
  - 3.3V to 3.3V: ≥75mA Available I_{LOAD}
- 3kV$_{RMS}$ Isolation Voltage
- Supports Infinite Capacitive Load
- 0.3% Load Regulation
- 0.3% Line Regulation
- Continuous Short-Circuit Protection (SCP)
- Over-Temperature Protection (OTP)
- CB Certification According to IEC 62368-1
- Meets EN55032 Class B Emissions
- -40°C to +125°C Operating Temperature Range
- Available in an SOIC-8 WB Package

APPLICATIONS

- Industrial Automation Systems
- Isolated Bias Power for Digital Isolators
- Isolated Power for Isolated RS-485, RS-422, and CAN Interfaces
- Isolated Sensor Power Supplies
- Telecom and Network Devices (5G RRUs, Industrial CPEs, Network Gateways, etc.)

TYPICAL APPLICATION





ORDERING INFORMATION

Part Number*	Package	Top Marking	MSL Rating
MIE05W0505BGYE-3R	SOIC-8 WB	*See Below*	3

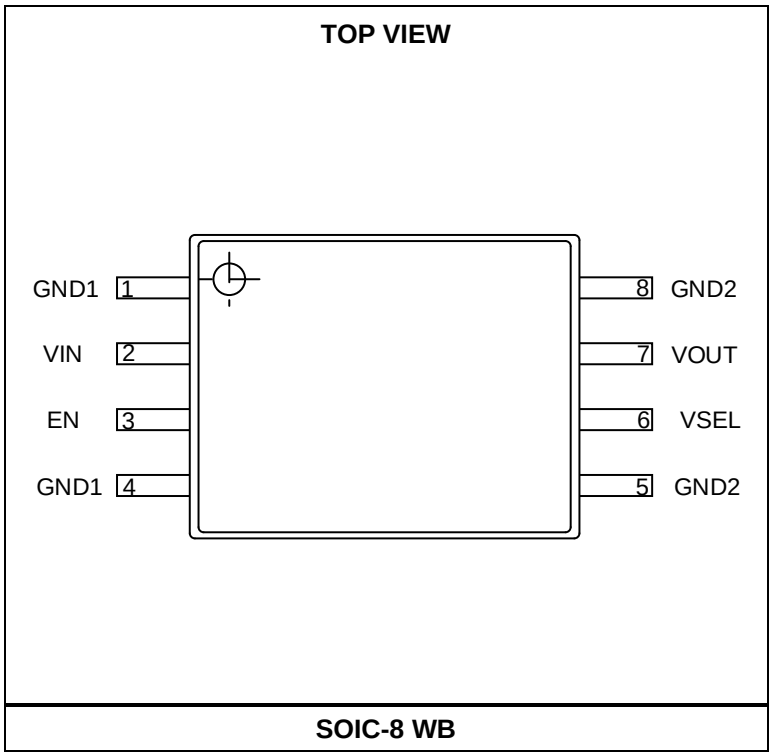
* For Tape & Reel, add suffix -Z (e.g. MIE05W0505BGYE-3R-Z).

TOP MARKING

05W0505B3
LLLLLLLLL
MPSYWW

05W0505B3: Part number
LLLLLLLLL: Lot number
MPS: MPS prefix
Y: Year code
WW: Week code

PACKAGE REFERENCE



SOIC-8 WB

PIN FUNCTIONS

Pin #	Name	Description
1, 4	GND1	**Power ground side 1.**
2	VIN	**Power input pin.** Connect the VIN pin to a 3V to 5.5V power supply. Connect a 10μF capacitor and a 0.1μF capacitor between the VIN and GND1 pins to stabilize the IC.
3	EN	**Enable pin.** Pull the EN pin high to enable the MIE05W0505BGYE; pull it low to disable the MIE05W0505BGYE. Do not leave this pin floating.
5, 8	GND2	**Power ground side 2.**
6	VSEL	**Output voltage setting pin.** For a 5V output, connect the VSEL pin to VOUT or float this pin. For a 3.3V output, connect the VSEL pin to GND2 (pin 8). Do not bias VSEL with another power source.
7	VOUT	**Power output pin.** It is recommended to connect a 22μF capacitor and a 0.1μF capacitor between VOUT and GND2 to decrease the output voltage (V_{OUT}) ripple and noise.

ABSOLUTE MAXIMUM RATINGS (1)

VIN/EN to GND1 ..... -0.3V to +6.5V
VOUT/TM to GND2 ..... -0.3V to +6.5V
Continuous power dissipation (T_A = 25°C) (2) 1.25W
Junction temperature (T_J) ..... 150°C
Lead temperature ..... 260°C
Storage temperature ..... -65°C to +150°C

ESD Ratings

Human body model (HBM) ..... ±5000V
Charged-device model (CDM) ..... ±2000V

Recommended Operating Conditions (3)

Input voltage (V_{IN}) ..... 3V to 5.5V
Output voltage (V_{OUT}) 5V/3.3V
Operating junction temp (T_J) .... -40°C to +125°C

Thermal Resistance	***θ_{JA}***	***θ_{JC}***	
SOIC-8 WB			
JESD51-7 (4)	100	17 ...	°C/W

Notes:

1) Exceeding these ratings may damage the device.
2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance θ_{JA}, and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX) - T_A) / θ_{JA}. Exceeding the maximum allowable power dissipation can produce an excessive die temperature, which may cause the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
3) The device is not guaranteed to function outside of its operating conditions.
4) The value of θ_{JA} given in this table is only valid for comparison with other packages and cannot be used for design purposes. These values were calculated in accordance with JESD51-7, and simulated on a specified JEDEC board. They do not represent the performance obtained in an actual application.

ELECTRICAL CHARACTERISTICS

V_{IN} = 5V, V_{OUT} = 5V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_J = -40°C to +125°C (6), typical value is tested at T_J = 25°C, all voltages with respect to the corresponding ground(s), unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply						
V_{IN} under-voltage lockout (UVLO) rising threshold	$V_{IN\_UVLO\_R}$	V_{IN} rising	2.45	2.6	2.75	V
V_{IN} UVLO threshold hysteresis	V_{IN_HYS}			220		mV
Shutdown current	I_{SD}	V_{EN} = 0V, measured on the VIN pin		7	50	µA
Input current	I_{IN}	Load = 0A, V_{OUT} = 5V		8	11	mA
		Load = 0.1A, V_{OUT} = 5V		216	300	mA
EN input high threshold					2	V
EN input voltage low threshold			0.4			V
EN input current leakage		EN connected to GND1	-7	-5		µA
Output voltage accuracy	V_{OUT_ACC}	V_{IN} = 4.5V to 5.5V, I_{OUT} = 0A	4.85	5	5.15	V
Load regulation (5)		Load = 0A to 0.1A		0.3		%
Line regulation (5)		V_{IN} = 4.5V to 5.5V, load = 0.1A		0.3		%
Efficiency (5)		Load = 0.1A		46		%
Ripple (5)		20MHz bandwidth		58		mV
Isolated voltage	V_{ISO}	Short all primary pins and all secondary pins as a two-terminal part, test time = 60s, qualified test	3			kV_{RMS}
		Short all primary pins and all secondary pins as a two-terminal part, test time = 1s, production test, 100% test	3.6			kV_{RMS}
Input to output capacitance (5)	C_{I-O}	Short all primary pins and all secondary pins as a two-terminal part, measuring frequency = 1MHz		5		pF
Input to output resistance (5)	R_{I-O}	Short all primary pins and all secondary pins as a two-terminal part, test voltage = $500V_{DC}$	50			GΩ
Static common-mode transient immunity (CMTI) (5)	CMTI		100			kV/µs
Thermal Shutdown (5)						
Thermal shutdown temperature	T_{SD}			150		°C
Thermal shutdown hysteresis	T_{SD-HYS}			20		°C

ELECTRICAL CHARACTERISTICS *(continued)*

V_{IN} = 5V, V_{OUT} = 3.3V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_J = -40°C to +125°C (6), typical value is tested at T_J = 25°C, all voltages with respect to the corresponding ground(s), unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply						
Input current	I_{IN}	Load = 0A, V_{OUT} = 3.3V		5	7	mA
		Load = 0.1A, V_{OUT} = 3.3V		192	240	mA
EN input current leakage		EN connected to GND1	-7	-5		µA
Output voltage accuracy	V_{OUT_ACC}	V_{IN} = 4.5V to 5.5V, I_{OUT} = 0A	3.18	3.3	3.42	V
Load regulation (5)		Load = 0A to 0.1A		0.3		%
Line regulation (5)		V_{IN} = 4.5V to 5.5V, load = 0.1A		0.3		%
Efficiency (5)		Load = 0.1A		34		%
Ripple (5)		20MHz bandwidth		68		mV

ELECTRICAL CHARACTERISTICS *(continued)*

V_{IN} = 3.3V, V_{OUT} = 3.3V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_J = -40°C to +125°C (6), typical value is tested at T_J = 25°C, all voltages with respect to the corresponding ground(s), unless otherwise noted.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply						
Shutdown current	I_{SD}	V_{EN} = 0V, measured on the VIN pin		5	30	µA
Input current	I_{IN}	Load = 0A, V_{OUT} = 3.3V		5	8	mA
		Load = 0.075A, V_{OUT} = 3.3V		172	255	mA
EN input current leakage		EN connected to GND1	-5	-3.3		µA
Output voltage accuracy	V_{OUT_ACC}	V_{IN} = 3V to 3.6V, I_{OUT} = 0A	3.18	3.3	3.42	V
Load regulation (5)		Load = 0A to 0.075A		0.3		%
Line regulation (5)		V_{IN} = 3V to 3.6V, load = 0.075A		0.1		%
Efficiency (5)		Load = 0.075A		44		%
Ripple (5)		20MHz bandwidth		24		mV

Notes:

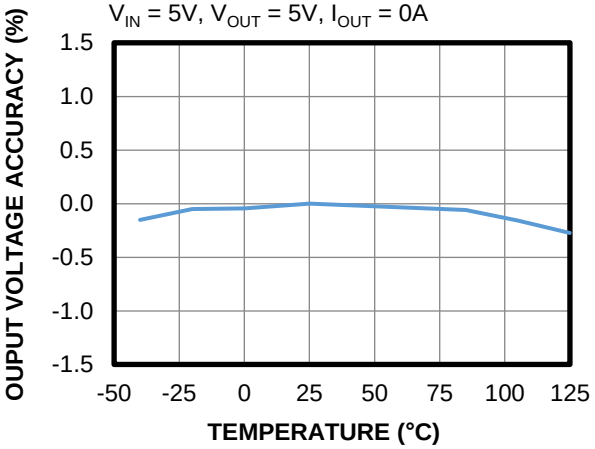
5) Guaranteed by engineering sample characterization.
6) Guaranteed by over-temperature (OT) correlation. Not tested in production.

TYPICAL CHARACTERISTICS

V_{IN} = 5V, V_{OUT} = 5V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_A = 25°C, unless otherwise noted.

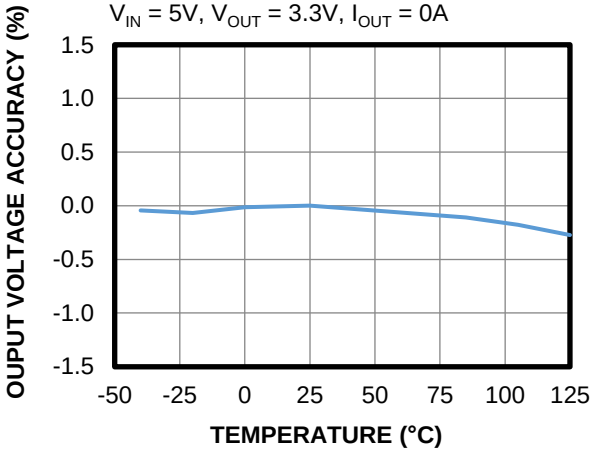
Output Voltage Accuracy vs. Temperature

V_{IN} = 5V, V_{OUT} = 5V, I_{OUT} = 0A



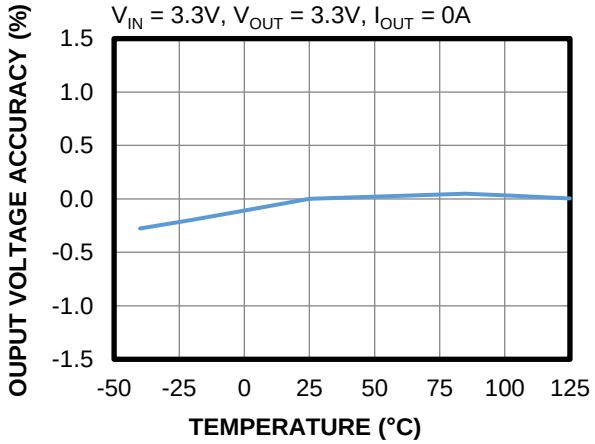
Output Voltage Accuracy vs. Temperature

V_{IN} = 5V, V_{OUT} = 3.3V, I_{OUT} = 0A



Output Voltage Accuracy vs. Temperature

V_{IN} = 3.3V, V_{OUT} = 3.3V, I_{OUT} = 0A

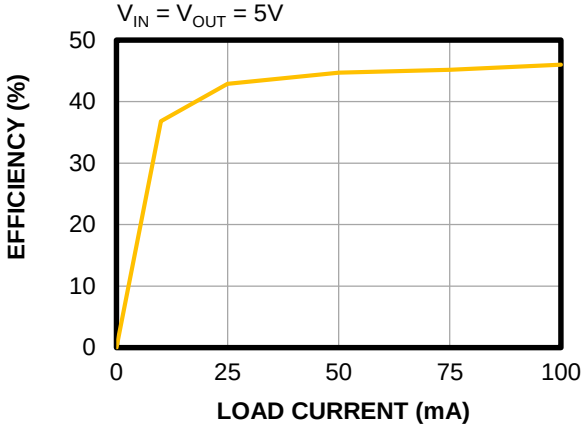


TYPICAL PERFORMANCE CHARACTERISTICS

V_{IN} = 5V, V_{OUT} = 5V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_A = 25°C, unless otherwise noted.

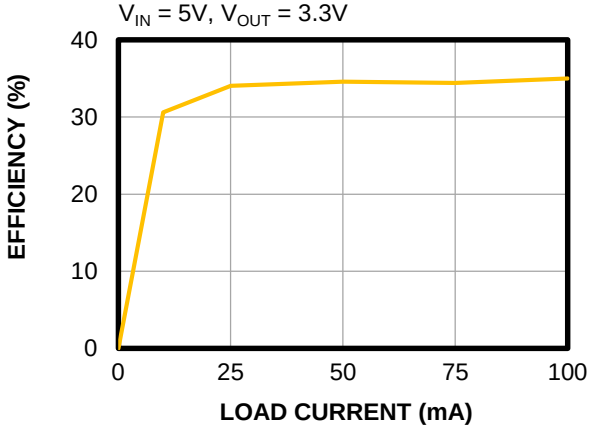
Efficiency vs. Load Current

V_{IN} = V_{OUT} = 5V



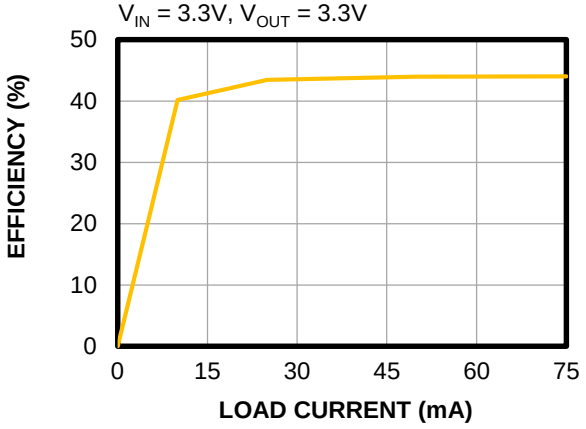
Efficiency vs. Load Current

V_{IN} = 5V, V_{OUT} = 3.3V



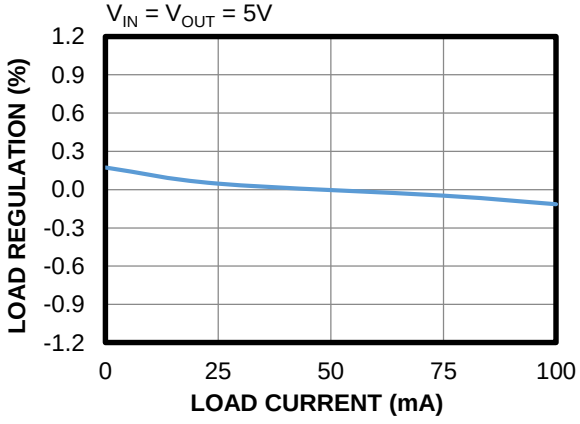
Efficiency vs. Load Current

V_{IN} = 3.3V, V_{OUT} = 3.3V



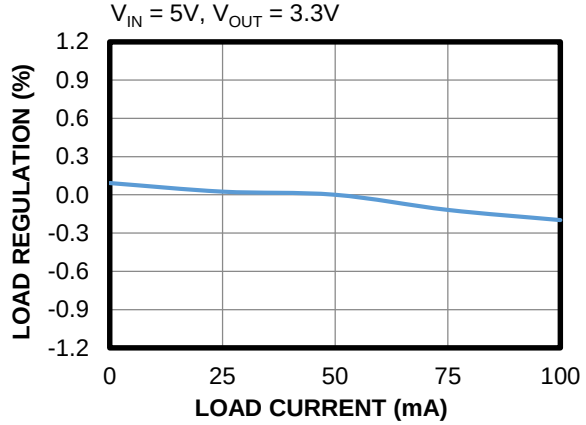
Load Regulation

V_{IN} = V_{OUT} = 5V



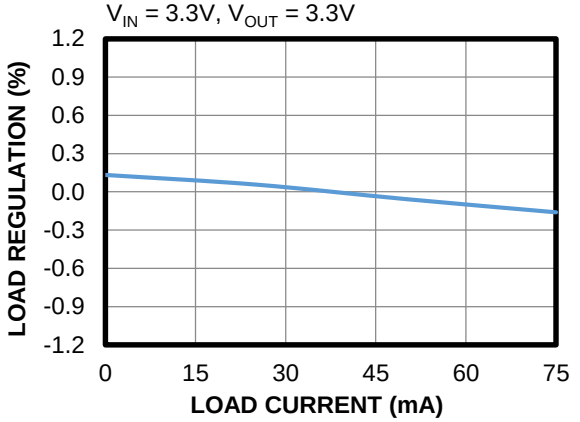
Load Regulation

V_{IN} = 5V, V_{OUT} = 3.3V



Load Regulation

V_{IN} = 3.3V, V_{OUT} = 3.3V

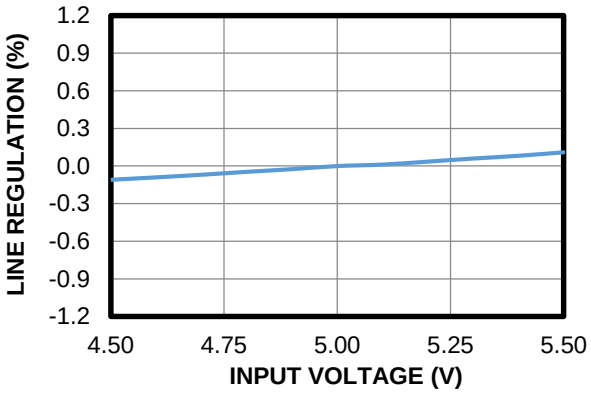


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

V_{IN} = 5V, V_{OUT} = 5V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_A = 25°C, unless otherwise noted.

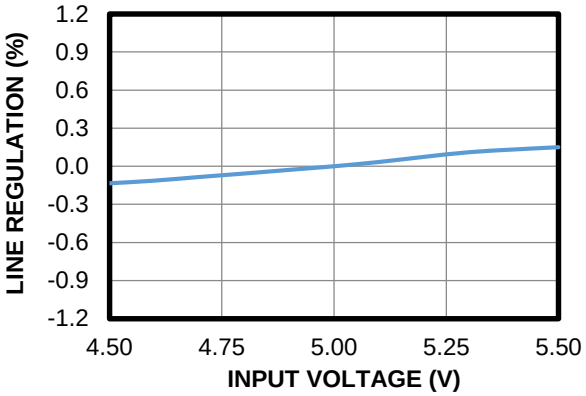
Line Regulation

V_{OUT} = 5V, I_{OUT} = 0.1A



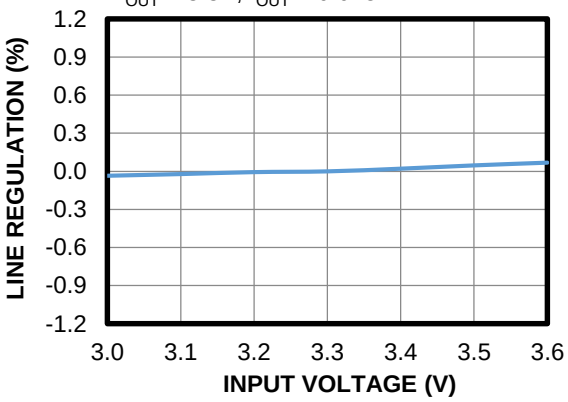
Line Regulation

V_{OUT} = 3.3V, I_{OUT} = 0.1A



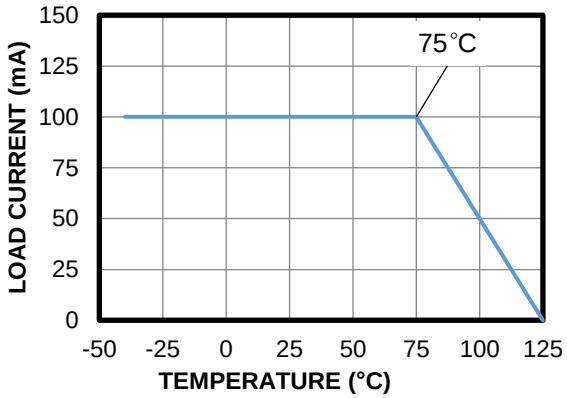
Line Regulation

V_{OUT} = 3.3V, I_{OUT} = 0.075A



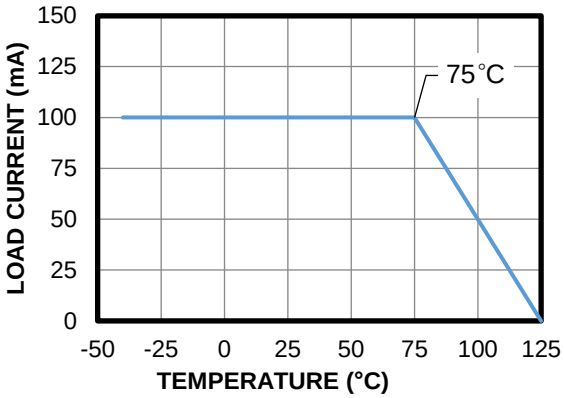
Load Current vs. Temperature

V_{IN} = 5V, V_{OUT} = 5V



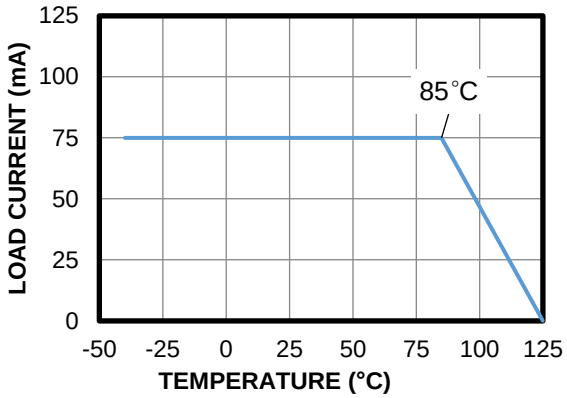
Load Current vs. Temperature

V_{IN} = 5V, V_{OUT} = 3.3V



Load Current vs. Temperature

V_{IN} = 3.3V, V_{OUT} = 3.3V

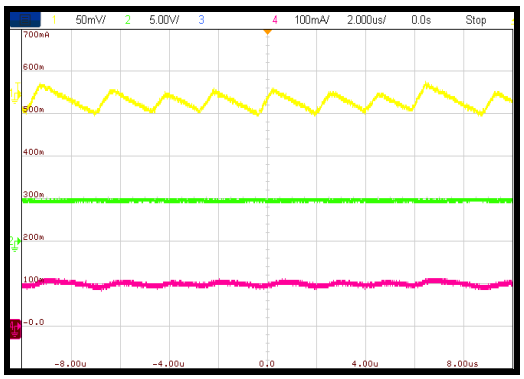


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

V_{IN} = 5V, V_{OUT} = 5V, C_{IN} = 0.1µF + 10µF, C_{OUT} = 0.1µF + 22µF, T_A = 25°C, unless otherwise noted.

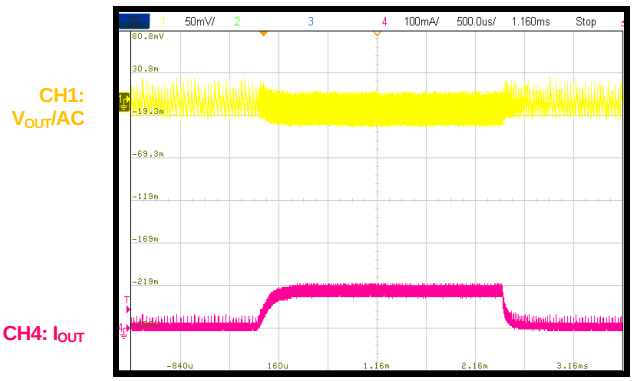
V_{OUT} Ripple

I_{OUT} = 0.1A



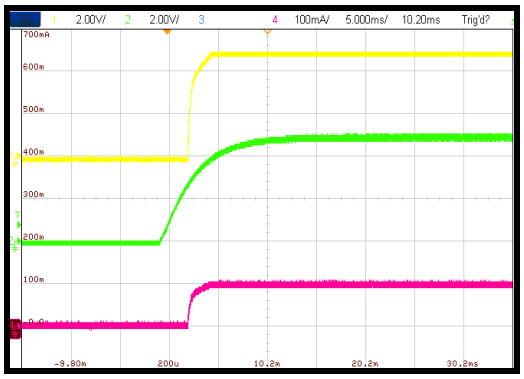
Load Transient

I_{OUT} = 0A to 0.1A



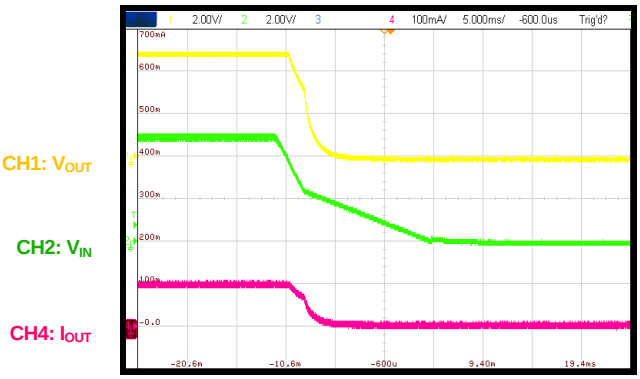
Start-Up through VIN

I_{OUT} = 0.1A



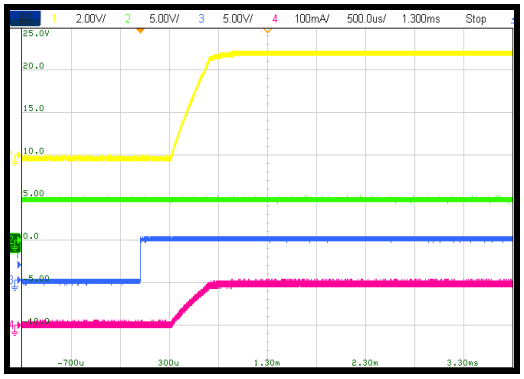
Shutdown through VIN

I_{OUT} = 0.1A



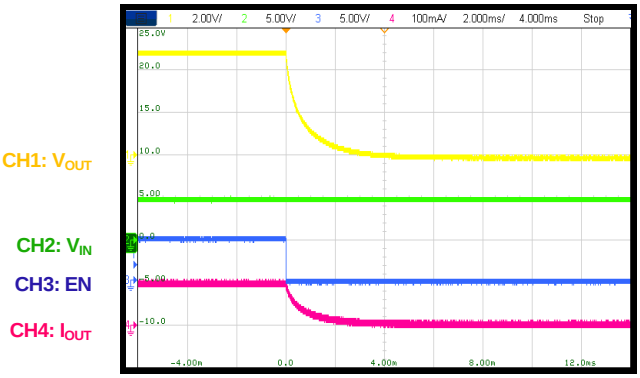
Start-Up through EN

I_{OUT} = 0.1A



Shutdown through EN

I_{OUT} = 0.1A



FUNCTIONAL BLOCK DIAGRAM

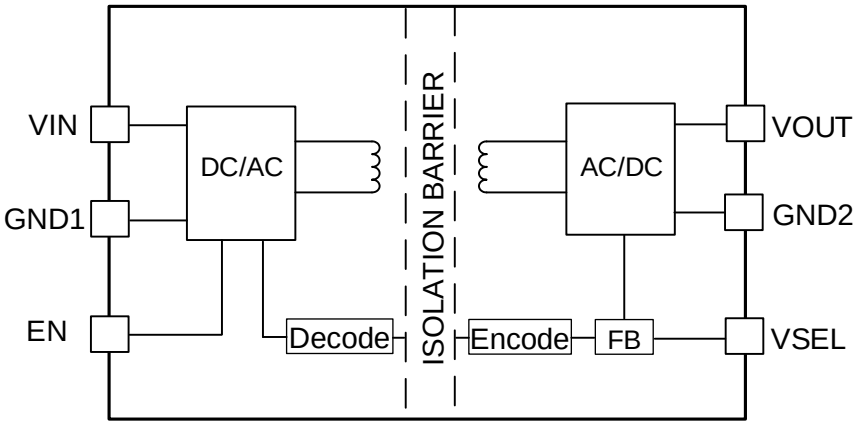


Figure1: Functional Block Diagram

OPERATION

The MIE05W0505BGYE is a regulated, isolated DC/DC module that can support 3V to 5.5V input voltage (V_{IN}) applications across a -40°C to +125°C operating temperature range. It has excellent load and line regulation, and supports up to 0.5W of output power (P_{OUT}).

Isolation Power Conversion

The MIE05W0505BGYE integrates power MOSFETs, transformer, and feedback (FB) circuit all in one chip, making it a high-performance, small-sized solution.

If the output voltage (V_{OUT}) is below the target voltage (3.3V or 5V), the IC starts switching to deliver power from V_{IN} to V_{OUT}. If V_{OUT} exceeds the target voltage, the device stops switching.

Setting the Output Voltage

To set V_{OUT} to 5V, float the VSEL pin or connect it to VOUT. The VOUT pin can output a 100mA load with a 4.5V to 5.5V V_{IN} range.

To set V_{OUT} to 3.3V, connect the VSEL to GND2. The VOUT pin can output a 100mA load with a 4.5V to 5.5V V_{IN} range, or a 75mA load with a 3V to 3.6V V_{IN} range. VSEL logic is locked during start-up. After start-up, V_{OUT} is fixed even if the VSEL logic is changed.

Under-Voltage Lockout Protection (UVLO)

The MIE05W0505BGYE has input under-voltage lockout (UVLO) protection to ensure reliable P_{OUT}. The MIE05W0505BGYE starts up once V_{IN} exceeds the UVLO rising threshold. The device shuts down when V_{IN} drops below the UVLO falling threshold. This function prevents the device from operating at an insufficient voltage. UVLO is a non-latch protection.

Enable (EN)

The EN pin enables and disables the MIE05W0505BGYE. When a voltage above 2V is applied to the EN pin and V_{IN} is above the V_{IN} UVLO threshold, the MIE05W0505BGYE enables all functions and begins switching. If the EN voltage (V_{EN}) falls below its lower threshold and (0.4V), switching is disabled. For automatic start-up, connect the EN pin to V_{IN} directly or through a resistor divider.

Power Converter Soft Start (SS) and Short-Circuit Protection (SCP)

To avoid overshoot and inrush current during start-up, the MIE05W0505BGYE has a built-in internal soft start (SS) function that gradually ramps up the output voltage (V_{OUT}).

The MIE05W0505BGYE starts up in constant current (CC) charging mode. In this mode, the current limit folds back, and I_{OUT} CC charges the output capacitor (C_{OUT}) until V_{OUT} rises to about 2.7V. After the CC charging period, the MIE05W0505BGYE's current limit returns to normal (does not fold back), with higher I_{OUT} capability. Such features guarantee infinite capacitive load.

During an overload or output short-circuit condition, V_{OUT} drops due to the internal current limit. Once V_{OUT} drops below about 2.2V, the MIE05W0505BGYE enters CC charging mode. After the over-current (OC) or short-circuit is condition removed and V_{OUT} rises to about 2.7V, the MIE05W0505BGYE resumes normal operation.

Over-Temperature Protection (OTP)

The MIE05W0505BGYE integrates one temperature monitoring circuit. If the junction temperature (T_J) exceeds 150°C, the MIE05W0505BGYE shuts down. Once the temperature drops below 130°C, the device restarts and resumes normal operation.

APPLICATION INFORMATION

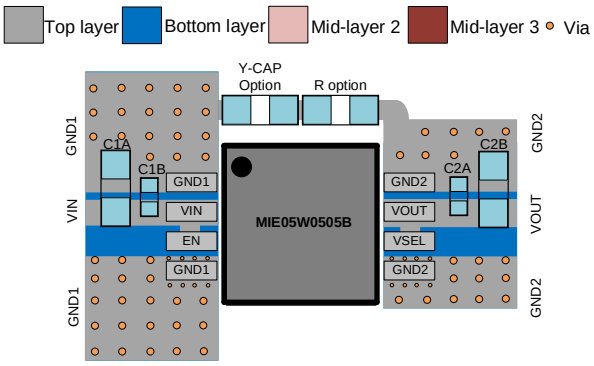
Selecting the Input and Output Capacitors

For stable operation, connect decoupling capacitors between the VIN and GND1 pins at the input side, and between the VOUT and GND2 pins at the output side. Place these decoupling capacitors as close to VIN and VOUT as possible. It is recommended to add one 10μF and one 0.1μF ceramic capacitor at the input, and to add one 22μF and one 0.1μF ceramic capacitor at output side. The higher-value capacitor is used to make the V_{OUT} ripple suitable, and the smaller one is used to filter high-frequency noise.

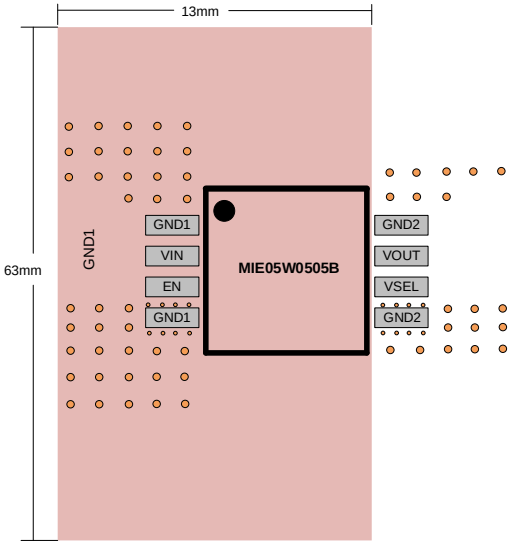
PCB Layout Guidelines

Efficient PCB layout is critical for stable operation. A 4-layer layout is recommended for good EMI performance. For the best results, refer to Figure 2 and follow the guidelines below:

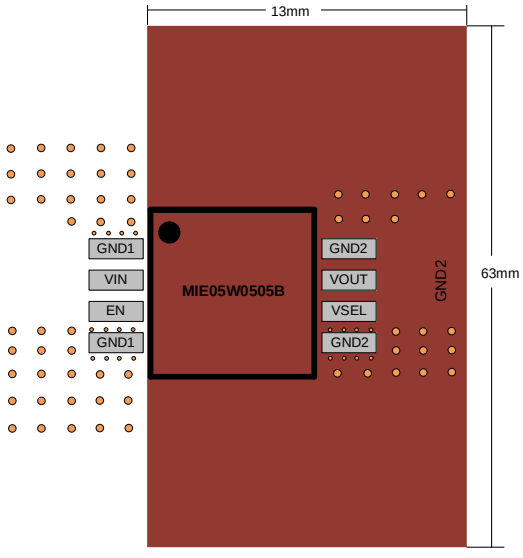
1. For safety, the primary side and secondary side should be physically separated. Ensure that the creepage/clearance meets the standards for the specified application.
2. To reduce output noise, minimize the loop area between VIN, the input capacitor, and GND1, as well as between VOUT, the output capacitor, and GND2.
3. Build a low-ESL overlap Y-capacitor to bypass EMI noise. Place sufficient vias on the GND1 and GND2 copper planes to reduce the Y-capacitor's ESL.
4. Place enough copper and vias around the IC's primary pin output to improve thermal performance. Do not place large copper areas on the GND2 and VOUT pins on the top layer; a 63mmx13mm area is recommend to shape the overlap Y-capacitor without an additional radiation loop.
5. It is recommended to place the external Y-capacitor and R option in series for EMI debugging. An SMD package for the Y-capacitor is recommended due to its lower ESL. The external Y-capacitor and R option should be close to the primary GND1 pin (pin 1) and secondary GND2 pin (pin 8) to decrease PCB trace ESL.



Top Layer and Bottom Layer



Mid-Layer 2



Mid-Layer 3

Figure 2: Recommended PCB Layout

TYPICAL APPLICATION CIRCUITS

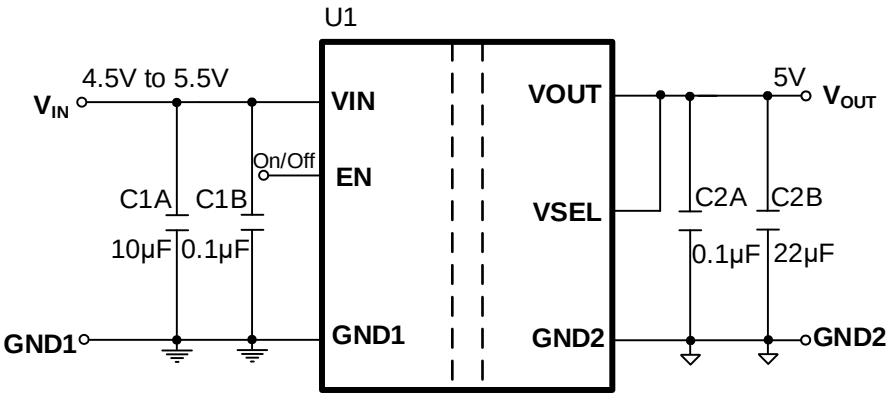


Figure 3: Typical Application Circuit with 5V Output

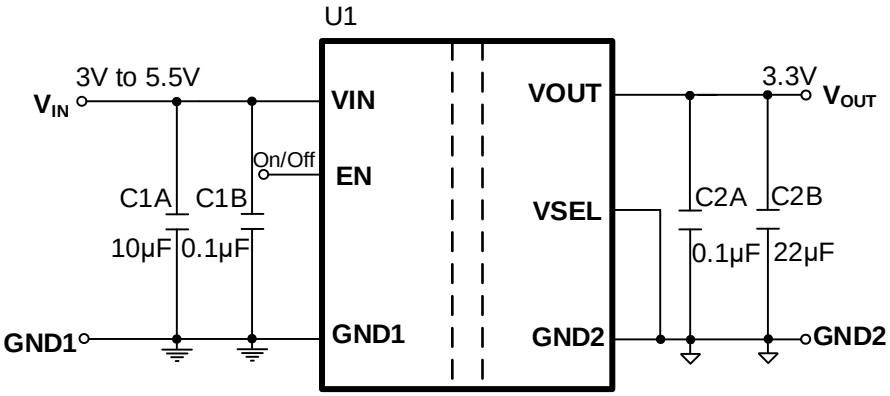
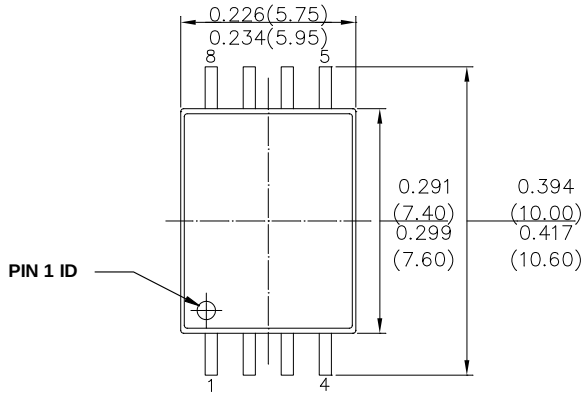


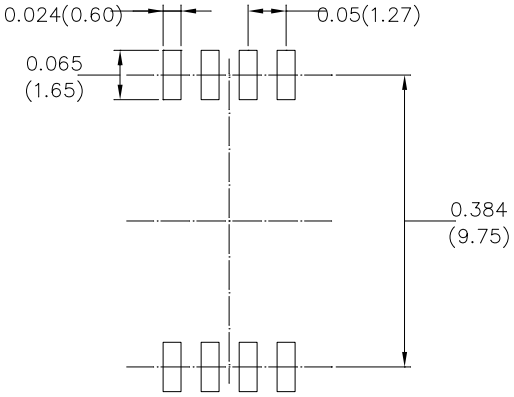
Figure 4: Typical Application Circuit with 3.3V Output

PACKAGE INFORMATION

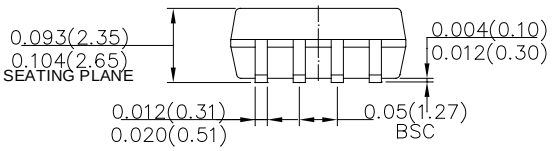
SOIC-8 WB



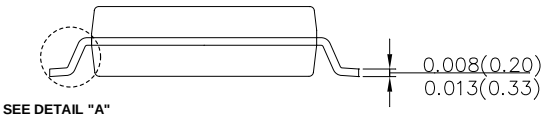
TOP VIEW



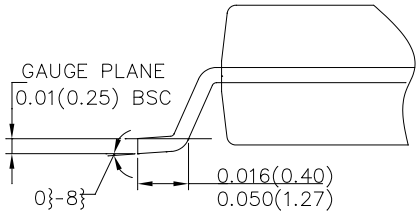
RECOMMENDED LAND PATTERN



FRONT VIEW



SIDE VIEW

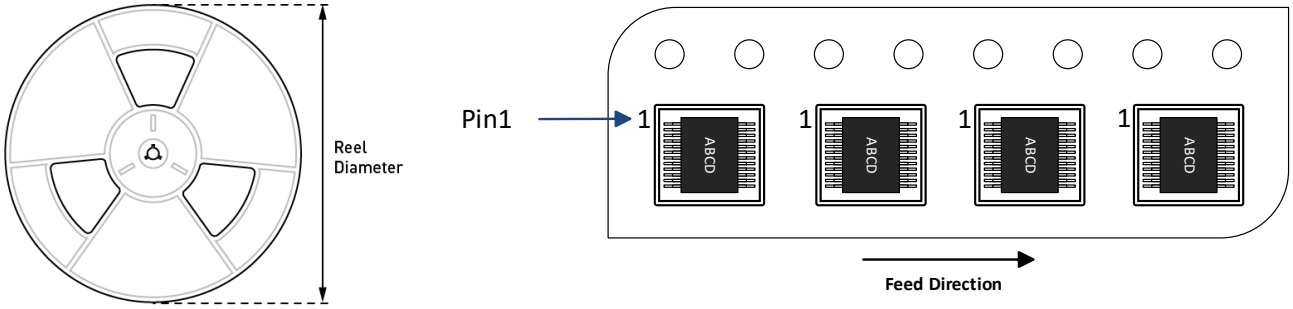


DETAIL "A"

NOTE:

1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
5) DRAWING REFERENCE TO JEDEC MS-013.
6) DRAWING IS NOT TO SCALE.

CARRIER INFORMATION



Part Number	Package Description	Quantity /Reel	Quantity /Tube	Quantity /Tray	Reel Diameter	Carrier Tape Width	Carrier Tape Pitch
MIE05W0505BGYE-3R-Z	SOIC-8 WB	1000	N/A	N/A	13in	16mm	12mm

REVISION HISTORY

Revision #	Revision Date	Description	Pages Updated
1.0	7/11/2024	Initial Release	-